

AO4421 60V P-Channel MOSFET

General Description

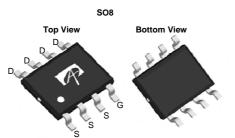
The AO4421 combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$. This device is ideal for load switch and battery protection applications.

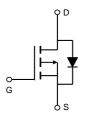
Product Summary

 $\begin{array}{ll} V_{DS} & -60V \\ I_{D} \; (at \; V_{GS} \!\!=\!\! -10V) & -6.2A \\ R_{DS(ON)} \; (at \; V_{GS} \!\!=\!\! -10V) & <40m\Omega \\ R_{DS(ON)} \; (at \; V_{GS} \!\!=\!\! -4.5V) & <50m\Omega \end{array}$

100% UIS Tested 100% R_g Tested







Absolute Maximum	Ratings	T ₄ =25℃ unless	otherwise noted

Parameter		Symbol	Maximum	Units	
Drain-Source Voltage		V _{DS}	-60	V	
Gate-Source Voltage		V_{GS}	±20	V	
Continuous Drain	T _A =25℃		-6.2		
Current ^A	T _A =70℃	I _D	-5	Α	
Pulsed Drain Current ^B		I _{DM}	-40		
	T _A =25℃	В	3.1	W	
Power Dissipation ^A	T _A =70℃	$-P_{D}$	2		
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	C	

Thermal Characteristics

Parameter		Symbol	Тур	Max	Units
Maximum Junction-to-Ambient A	t ≤ 10s	D	24	40	€\M
Maximum Junction-to-Ambient A	Steady-State	$R_{\theta JA}$	54	75	
Maximum Junction-to-Lead ^C	Steady-State	$R_{\theta JL}$	21	30	℃/W

Electrical Characteristics (T_J=25℃ unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
STATIC PARAMETERS							
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$		-60			V
I _{DSS}	Zero Gate Voltage Drain Current	V_{DS} =-48V, V_{GS} =0V				-1	^
			T _J =55℃			-5	μΑ
I _{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} =±20V				±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_{D}=-250\mu A$		-1	-2	-3	V
I _{D(ON)}	On state drain current	V_{GS} =-10V, V_{DS} =-5V		-40			Α
	Static Drain-Source On-Resistance	V_{GS} =-10V, I_{D} =-6.2A			32	40	mΩ
$R_{DS(ON)}$			T _J =125℃		53	70	11152
		V_{GS} =-4.5V, I_D =-5A			40	50	mΩ
g _{FS}	Forward Transconductance	V_{DS} =-5V, I_{D} =-6.2A	V _{DS} =-5V, I _D =-6.2A		18		S
V_{SD}	Diode Forward Voltage	I _S =-1A,V _{GS} =0V			-0.74	-1	V
Is	Maximum Body-Diode Continuous Curr	ent			-4.2	Α	
DYNAMIC	PARAMETERS						
C _{iss}	Input Capacitance	V_{GS} =0V, V_{DS} =-30V, f=1MHz V_{GS} =0V, V_{DS} =0V, f=1MHz			2417	2900	pF
C _{oss}	Output Capacitance				179		pF
C_{rss}	Reverse Transfer Capacitance				120		pF
R_g	Gate resistance				1.9	2.3	Ω
SWITCHI	NG PARAMETERS						
Q _g (10V)	Total Gate Charge (10V)	V _{GS} =-10V, V _{DS} =-30V, I _D =-6.2A			46.5	55	nC
Q _g (4.5V)	Total Gate Charge (4.5V)				22.7		nC
Q_{gs}	Gate Source Charge				9.1		nC
Q_{gd}	Gate Drain Charge				9.2		nC
t _{D(on)}	Turn-On DelayTime				9.8		ns
t _r	Turn-On Rise Time	V_{GS} =-10V, V_{DS} =-30V, R_L =4.7 Ω , R_{GEN} =3 Ω			6.1		ns
t _{D(off)}	Turn-Off DelayTime				44		ns
t _f	Turn-Off Fall Time				12.7		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =-6.2A, dI/dt=100A	/μs		34	42	ns
Q_{rr}	Body Diode Reverse Recovery Charge	I _F =-6.2A, dI/dt=100A	/μs		47		nC

A: The value of R_{0JA} is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any a given application depends on the user's specific board design. The current rating is based on the t \leq 10s thermal resistance rating.

THIS PRODUCT HAS BEEN DESIGNED AND QUALIFIED FOR THE CONSUMER MARKET. APPLICATIONS OR USES AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS ARE NOT AUTHORIZED. AOS DOES NOT ASSUME ANY LIABILITY ARISING OUT OF SUCH APPLICATIONS OR USES OF ITS PRODUCTS. AOS RESERVES THE RIGHT TO IMPROVE PRODUCT DESIGN, FUNCTIONS AND RELIABILITY WITHOUT NOTICE

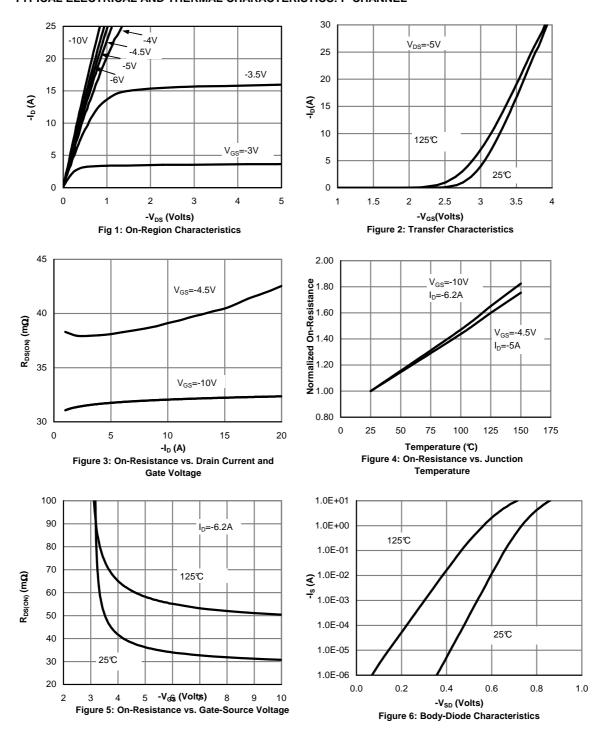
B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6,12,14 are obtained using 80 µs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T $_A$ =25°C. The SOA curve provides a single pulse rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS: P-CHANNEL



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS: P-CHANNEL

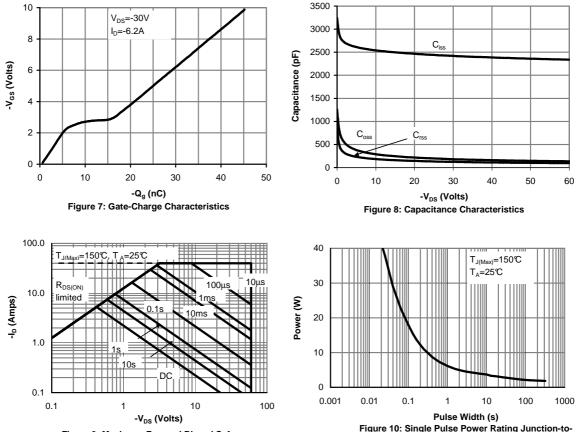


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

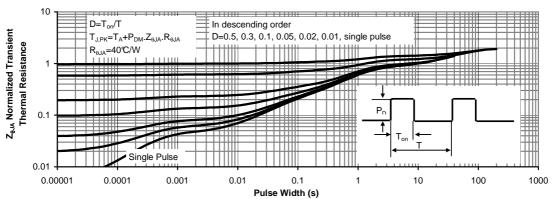


Figure 11: Normalized Maximum Transient Thermal Impedance